

Electronic Supplementary Material (ESI) for New Journal of Chemistry

Cooperative assembly of redistributed aryl-germanium bearing alkoxy silane in mesostructured siloxane network

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S1: Experimental section: Synthesis and characterization of Ph₃GeSi, Ph₂GeSi₂ and PhGeSi₃

S2. Infrared spectra of bimetallic silyl-germyl precursors Ph₃GeSi, Ph₂GeSi₂ and PhGeSi₃

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S4. CP MAS ¹³C and ²⁹Si NMR spectra of Ph₃GeSi@SiO₂, Ph₂GeSi₂@SiO₂ and PhGeSi₃@SiO₂

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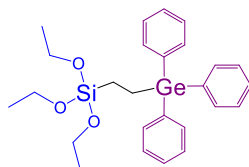
S9. EDX of CS-Ph₃GeSi@SiO_{2-f}, CS-Ph₂GeSi₂@SiO_{2-f} and CS-PhGeSi₃@SiO_{2-f}

S10. Digital photos and Infrared spectra of CS-Ph₃GeSi@SiO_{2-f-150}°C, CS-Ph₂GeSi₂@SiO_{2-f-150}°C and CS-PhGeSi₃@SiO_{2-f-150}°C

S1: Experimental section:

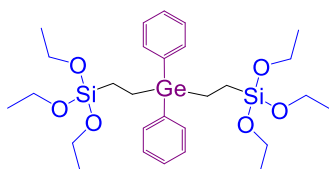
S1a: Synthesis and characterization of Ph_3GeSi , Ph_2GeSi_2 and PhGeSi_3

Synthesis and characterization of Ph_3GeSi



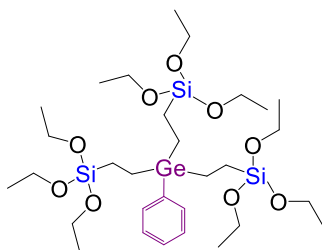
A solution of triethoxyvinylsilane (0.46 g, 2.42 mmol) and triphenylgermane (0.75 g, 2.45 mmol) in toluene (2 ml) was heated in the presence of AIBN at 90°C for 2h. After evaporation of solvent, Ph_3GeSi (1.10 g, 91%) was obtained as a white powder. M.p. 57 °C; δ_{H} (300.13 MHz; CDCl_3 ; Me_4Si) 0.69-0.75 (2 H, m, $\text{CH}_2\text{-Si}$), 1.12 (9 H, t, J 7.0, $\text{OCH}_2\text{-CH}_3$), 1.48-1.54 (2 H, m, ($\text{CH}_2\text{-Ge}$), 3.71 (6 H, q, J 7.0, $\text{OCH}_2\text{-CH}_3$), 7.25-7.41 (15 H, m, C_6H_5); δ_{C} (75.48 MHz; CDCl_3 ; Me_4Si) 4.71 ($\text{CH}_2\text{-Si}$), 5.84 ($\text{CH}_2\text{-Ge}$), 18.51 (OCH_2CH_3), 58.62 (OCH_2CH_3), 128.36 (C_m), 129.04 (C_p), 135.19 (C_o), 137.11 (C_{ipso}); δ_{Si} (59.62 MHz; CDCl_3 ; Me_4Si) -45.88; MS (EI): m/z = 496 (1) $[\text{M}]^+$.

Synthesis and characterization of Ph_2GeSi_2



A solution of triethoxyvinylsilane (1.86 g, 9.78 mmol) and diphenylgermane (1.13 g, 4.91 mmol) in toluene (5 mL) was heated in the presence of AIBN at 90°C for 2h. After evaporation of solvent and distillation under reduced pressure, Ph_2GeSi_2 (2.70 g, 90%) was obtained as a colorless liquid. Bp: 140°C / 0.3 mmHg; δ_{H} (300.13 MHz; CDCl_3 ; Me_4Si) 0.59-0.64 (4 H, m, $\text{CH}_2\text{-Si}$), 1.13 (18 H, t, J 7.0, $\text{OCH}_2\text{-CH}_3$), 1.20-1.27 (4 H, m, ($\text{CH}_2\text{-Ge}$), 3.72 (12 H, q, J 7.0, $\text{OCH}_2\text{-CH}_3$), 7.24-7.27 (6 H, m, C_6H_5), 7.36-7.38 (4 H, m, C_6H_5); δ_{C} (75.48 MHz; CDCl_3 ; Me_4Si) 4.28 ($\text{Si-CH}_2\text{-CH}_2\text{-Ge}$), 18.40 (OCH_2CH_3), 58.51 (OCH_2CH_3), 128.11 (C_m), 128.66 (C_p), 134.71(C_o), 137.93 (C_{ipso}); δ_{Si} (59.62 MHz; CDCl_3 ; Me_4Si) -45.77; MS (EI): m/z = 533 (3) $[\text{M-Ph}]^+$.

Synthesis and characterization of PhGeSi_3



A solution of triethoxyvinylsilane (2.36 g, 12.42 mmol) and phenylgermane (0.63 g, 4.12 mmol) in toluene (5 ml) was heated in the presence of AIBN at 90°C for 3h. After evaporation of solvent and distillation under reduced pressure, PhGeSi_3 (2.62 g, 88 %) was obtained as a colorless liquid. Bp: 140°C/0.04 mmHg; δ_{H} (300.13 MHz; CDCl_3 ; Me_4Si) 0.55-0.61 (6 H, m, $\text{CH}_2\text{-Si}$), 0.96-1.02 (6 H, m, $\text{CH}_2\text{-Ge}$), 1.15 (27 H, t, J 7.0, $\text{OCH}_2\text{-CH}_3$), 3.71 (18 H, q, J 7.0, $\text{OCH}_2\text{-CH}_3$), 7.22-7.26 (3 H, m, C_6H_5), 7.33-7.35 (2 H, m, C_6H_5); δ_{C} (75.48 MHz; CDCl_3 ; Me_4Si) 2.14, 3.16 ($\text{Si-CH}_2\text{-CH}_2\text{-Ge}$), 17.27 (OCH_2CH_3), 57.35

(OCH₂CH₃), 126.81 (C_m), 127.18 (C_p), 133.07 (C_o), 137.98 (C_{ipso}); δ_{Si} (59.62 MHz; CDCl₃; Me₄Si) -45.72; MS (EI): $m/z = 724$ (1) [M]⁺.

S1b: Synthesis of Ph₃GeSi@SiO₂, Ph₂GeSi₂@SiO₂ and PhGeSi₃@SiO₂

Synthesis of Ph₃GeSi@SiO₂

The Pluronic P123 (0.9 g) was dissolved in an aqueous HCl solution (5.1 g of HCl 37%, in 25 g H₂O) with stirring at room temperature for 4 h. TEOS (1.89 g, 9.09 mmol) was added dropwise to this homogeneous solution. After 15 min, the **Ph₃GeSi** precursor (0.5 g, 1.01 mmol of Si) was added to the reaction mixture. The resulting mixture was kept stirring at 40 °C for 20 h and heated at 100°C under static conditions for an additional 24 h. After cooling, the solid product was recovered by filtration, successively washed with deionized water and ethanol to neutrality, and drying in air at 60 °C for 12 h giving 1.6 g of material as a white powder. The surfactant was removed by extraction in a Soxhlet with 250 mL of ethanol containing 2 mL of 37 % HCl aqueous solution at reflux temperature for 72 h. The recovered solid was washed with ethanol and air-dried at 60 °C.

Synthesis of Ph₂GeSi₂@SiO₂

The Pluronic P123 (1.46 g) was dissolved in an aqueous HCl solution (8.18 g of HCl 37%, in 36 g H₂O) with stirring at room temperature for 4 h. TEOS (3.07 g, 14.76 mmol) was added dropwise to this homogeneous solution. After 15 min, the **Ph₂GeSi₂** precursor (0.5 g, 0.82 mmol of Si) was added to the reaction mixture. The resulting mixture was kept stirring at 40 °C for 20 h and heated at 100°C under static conditions for an additional 24 h. After cooling, the solid product was recovered by filtration, successively washed with deionized water and ethanol to neutrality, and drying in air at 60 °C for 12 h giving 2.2 g of material as a white powder. The surfactant was removed by extraction in a Soxhlet with 250 mL of ethanol containing 2 mL of 37 % HCl aqueous solution at reflux temperature for 72 h. The recovered solid was washed with ethanol and air-dried at 60 °C.

Synthesis of PhGeSi₃@SiO₂

The Pluronic P123 (1.84 g) was dissolved in an aqueous HCl solution (10.28 g of HCl 37%, in 46 g H₂O) with stirring at room temperature for 4 h. TEOS (3.88 g, 18.65 mmol) was added dropwise to this homogeneous solution. After 15 min, the **PhGeSi₃** precursor (0.5 g, 0.69 mmol of Si) was added to the reaction mixture. The resulting mixture was kept stirring at 40 °C for 20 h and heated at 100°C under static conditions for an additional 24 h. After cooling, the solid product was recovered by filtration, successively washed with deionized water and ethanol to neutrality, and drying in air at 60 °C for 12 h giving 2.33 g of material as a white powder. The surfactant was removed by extraction in a Soxhlet with 250 mL of ethanol containing 2 mL of 37 % HCl aqueous solution at reflux temperature for 72 h. The recovered solid was washed with ethanol and air-dried at 60 °C.

S1c: Preparation of Chitosan–Ph_nGeSi_{4-n}@SiO₂ Films.

Preparation of CS–Ph₃GeSi@SiO₂-f

50 mg of chitosan was completely dissolved in 4 mL of 1% (v/v) acetic acid solution, and the mixture was kept under vigorous stirring for 120 min. tetraethylorthosilicate (7 mg) and **Ph₃GeSi** (7 mg) were added to the chitosan solution, and the resulting mixture was stirred for an additional 90 min. The resulting solution was cast into plastic Petri dishes allowing solvent removal and film formation after complete drying.

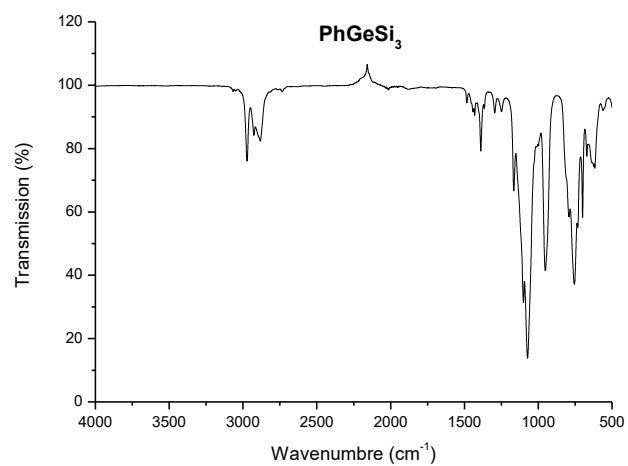
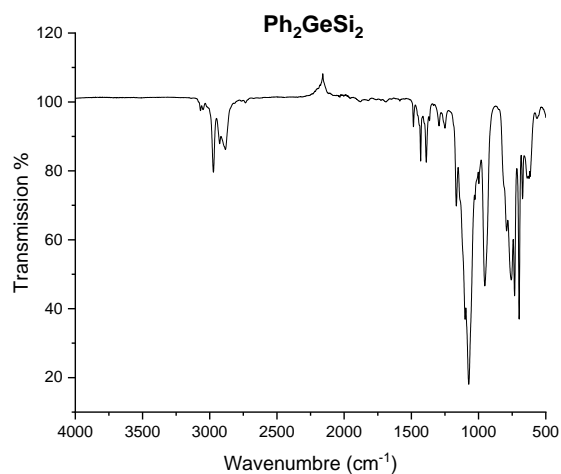
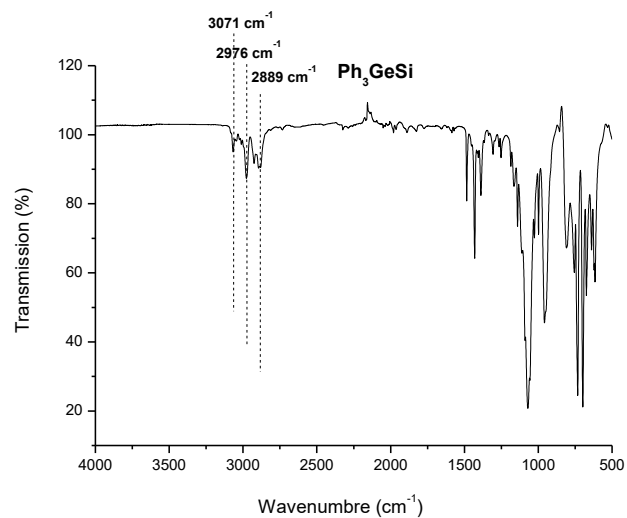
Preparation of CS–Ph₂GeSi₂@SiO₂-f

50 mg of chitosan was completely dissolved in 4 mL of 1% (v/v) acetic acid solution, and the mixture was kept under vigorous stirring for 120 min. tetraethylorthosilicate (8.8 mg) and **Ph₂GeSi₂** (8.8 mg) were added to the chitosan solution, and the resulting mixture was stirred for an additional 90 min. The resulting solution was cast into plastic Petri dishes allowing solvent removal and film formation after complete drying.

Preparation of CS–PhGeSi₃@SiO₂-f

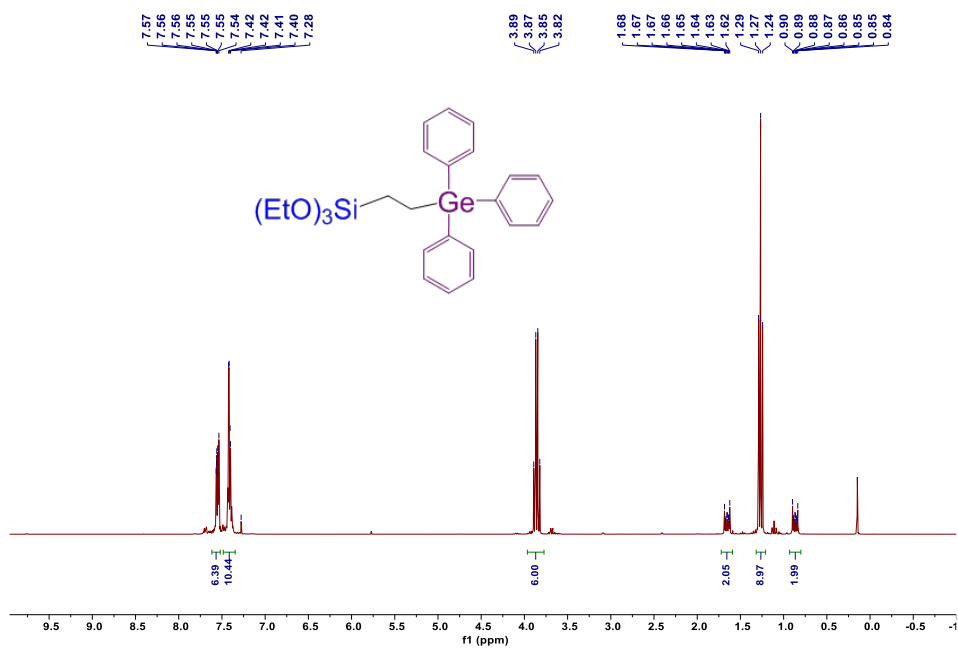
50 mg of chitosan was completely dissolved in 4 mL of 1% (v/v) acetic acid solution, and the mixture was kept under vigorous stirring for 120 min. tetraethylorthosilicate (10.5 mg) and **PhGeSi₃** (10.5 mg) were added to the chitosan solution, and the resulting mixture was stirred for an additional 90 min. The resulting solution was cast into plastic Petri dishes allowing solvent removal and film formation after complete drying.

S2. Infrared spectra of bimetallic silyl-germyl precursors Ph_3GeSi , Ph_2GeSi_2 and PhGeSi_3

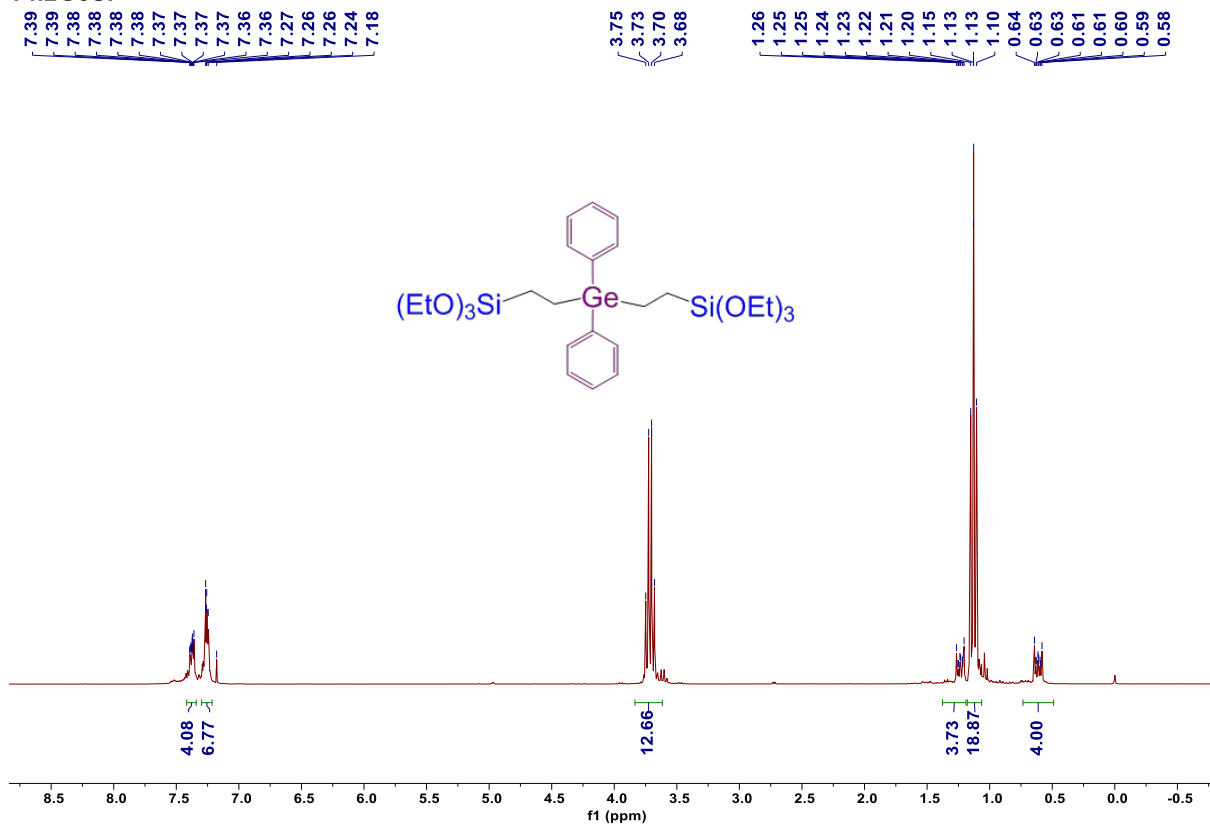


S3. ^1H , ^{13}C and ^{29}Si NMR spectra of bimetallic silyl-germyl precursors **Ph_3GeSi** , **Ph_2GeSi_2** and **PhGeSi_3**

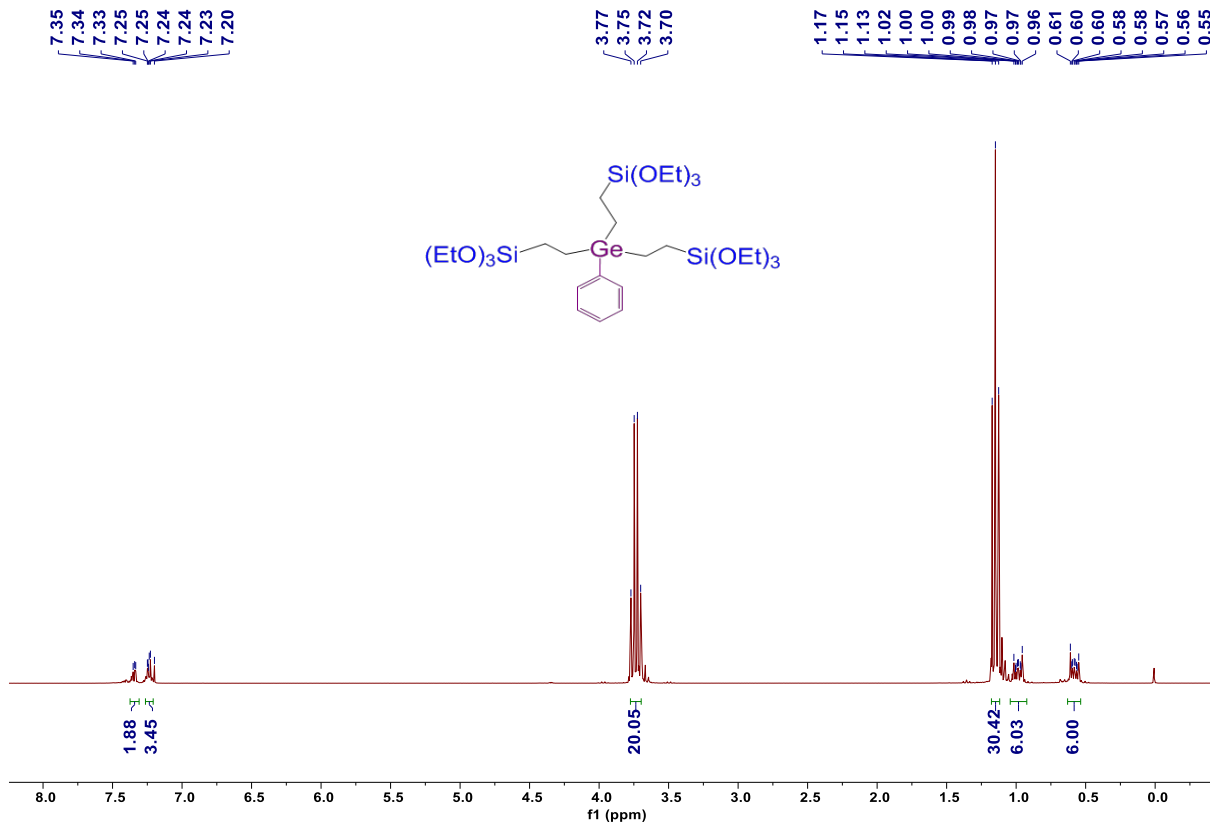
Ph_3GeSi



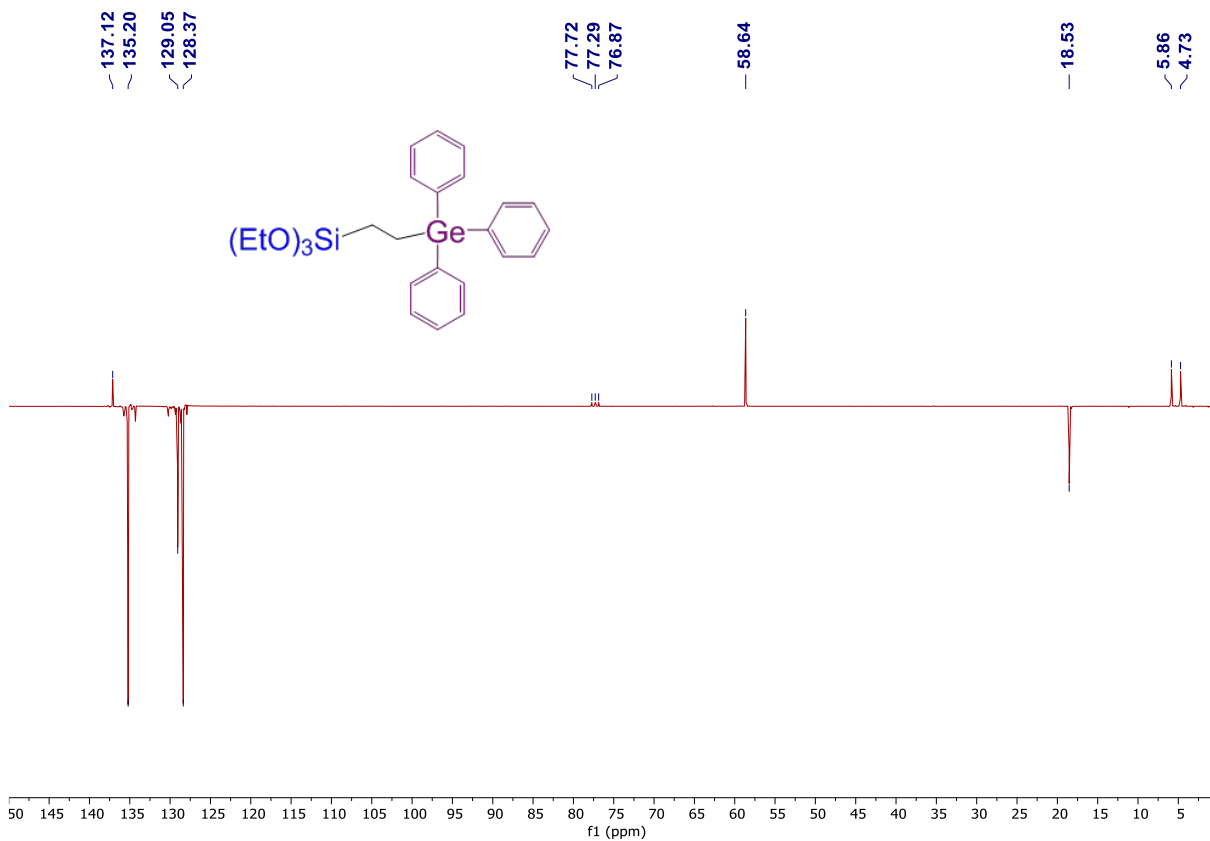
Ph_2GeSi_2



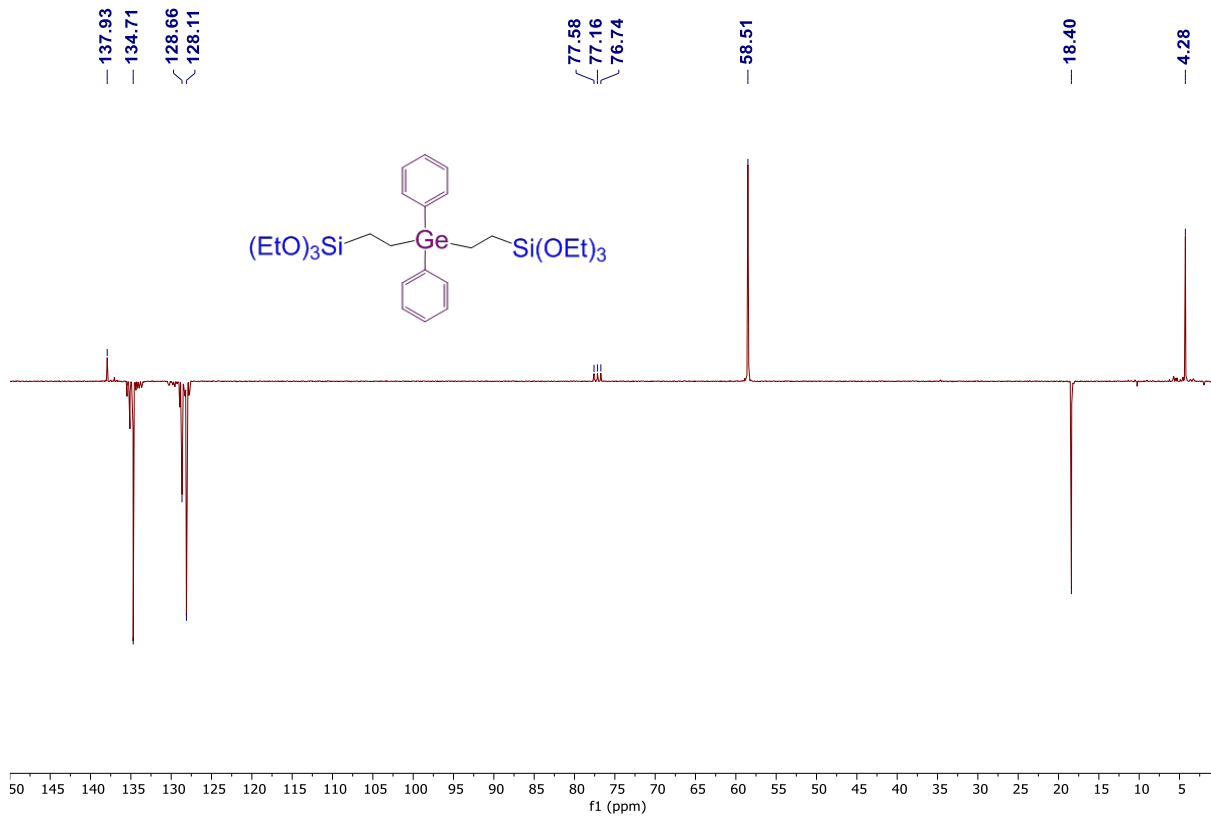
PhGeSi3



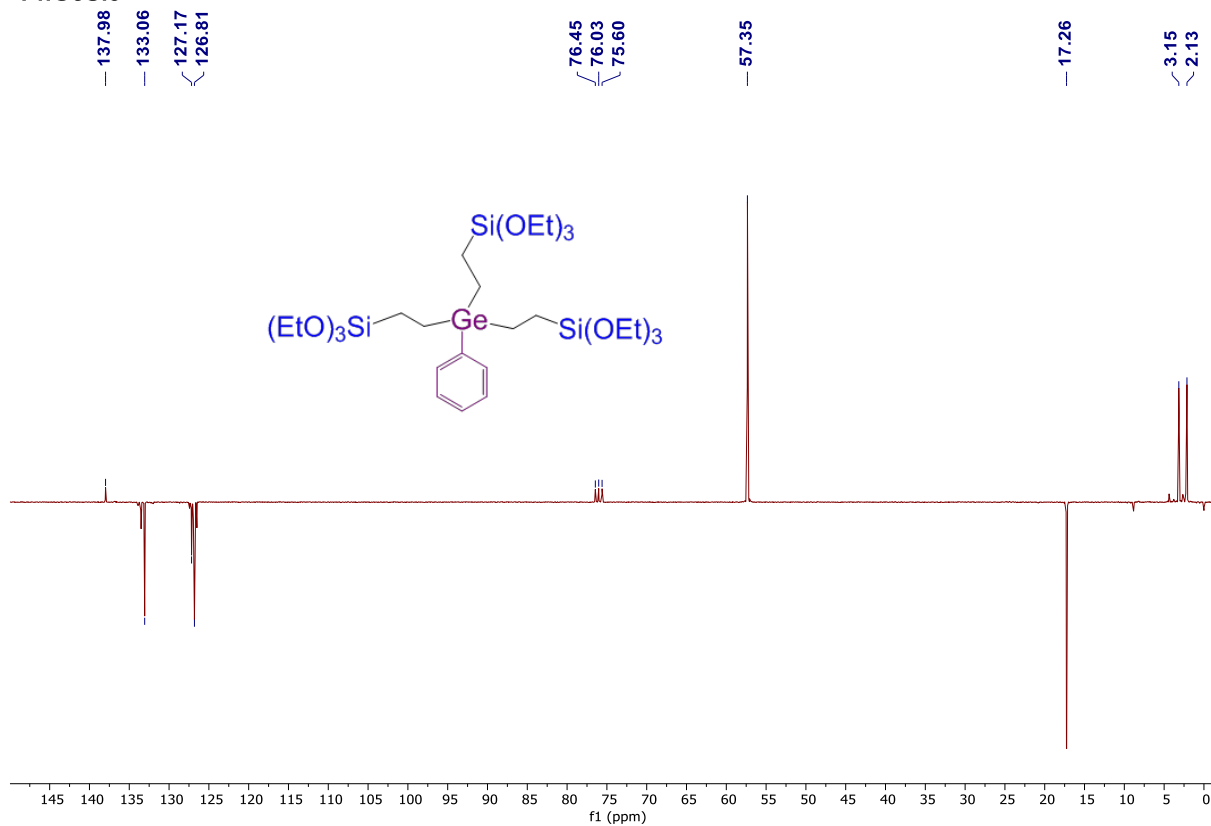
Ph3GeSi



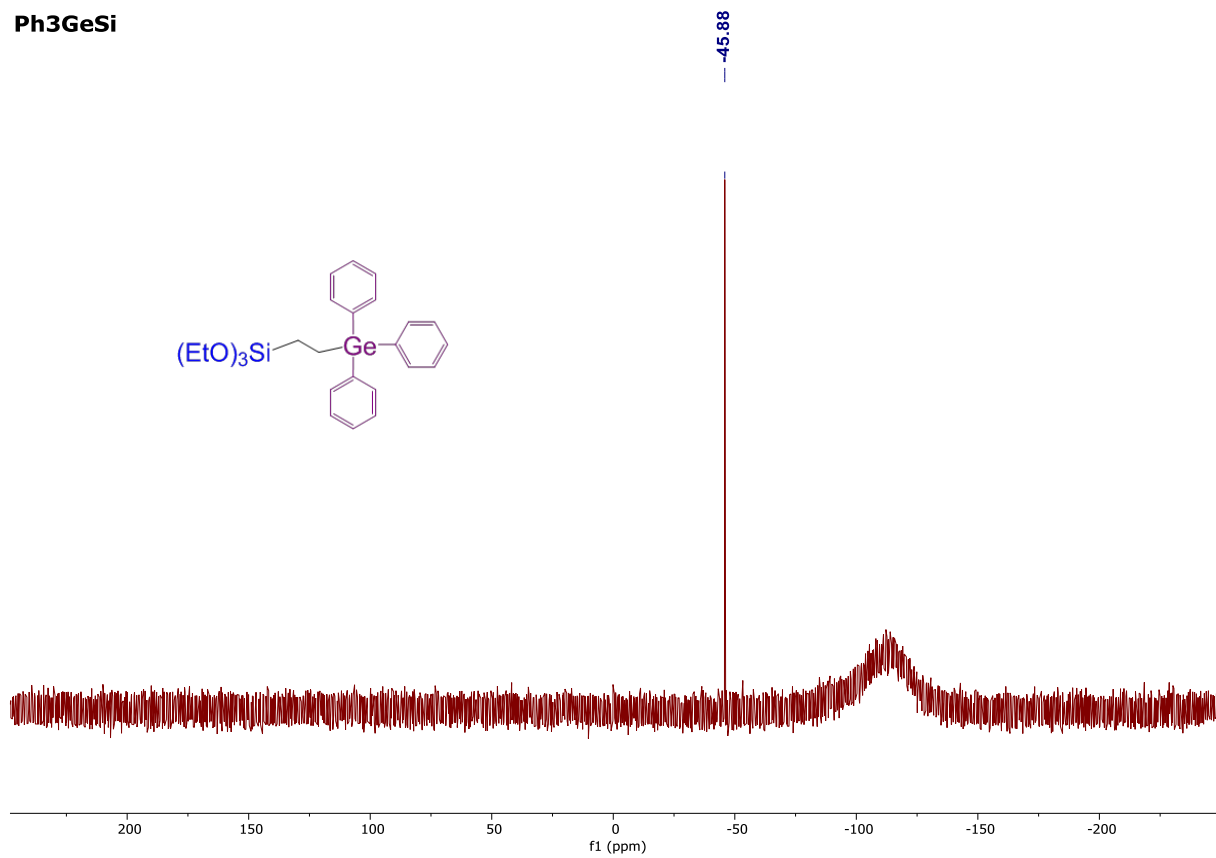
Ph₂GeSi₂



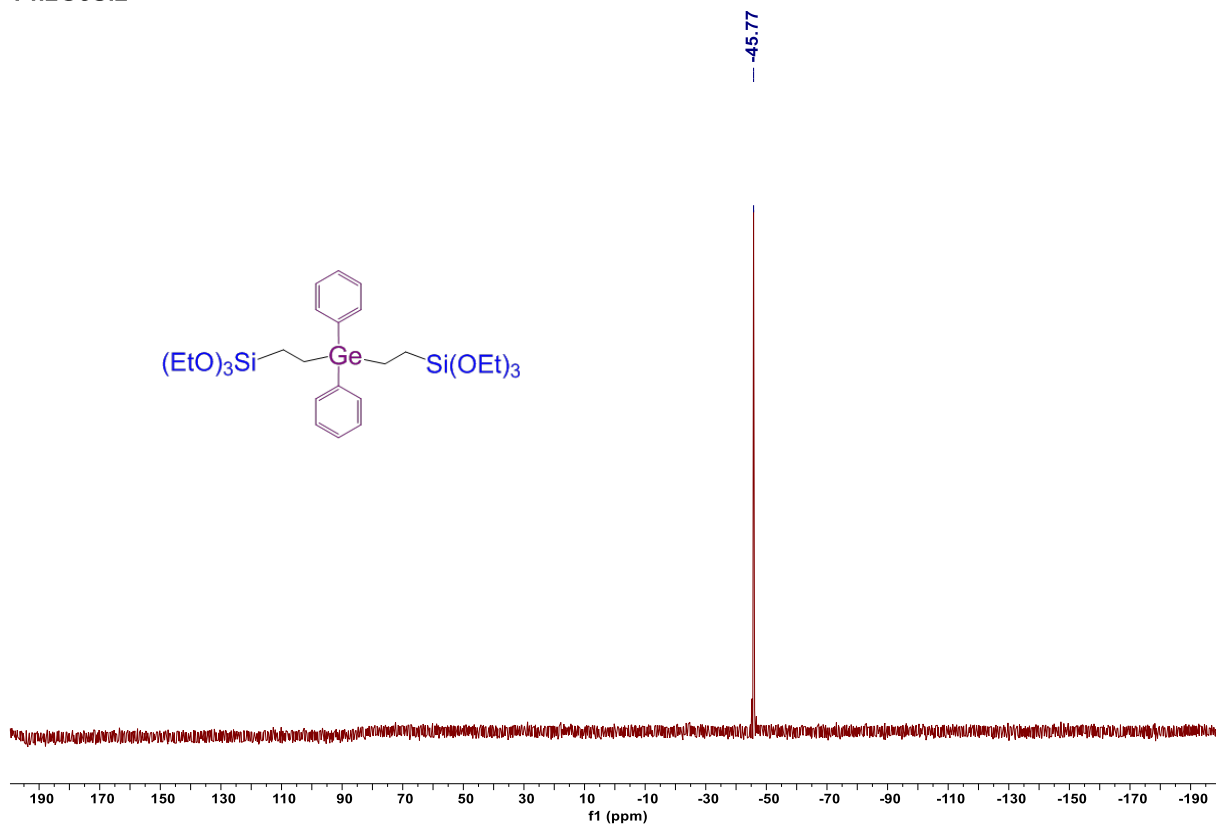
PhGeSi₃



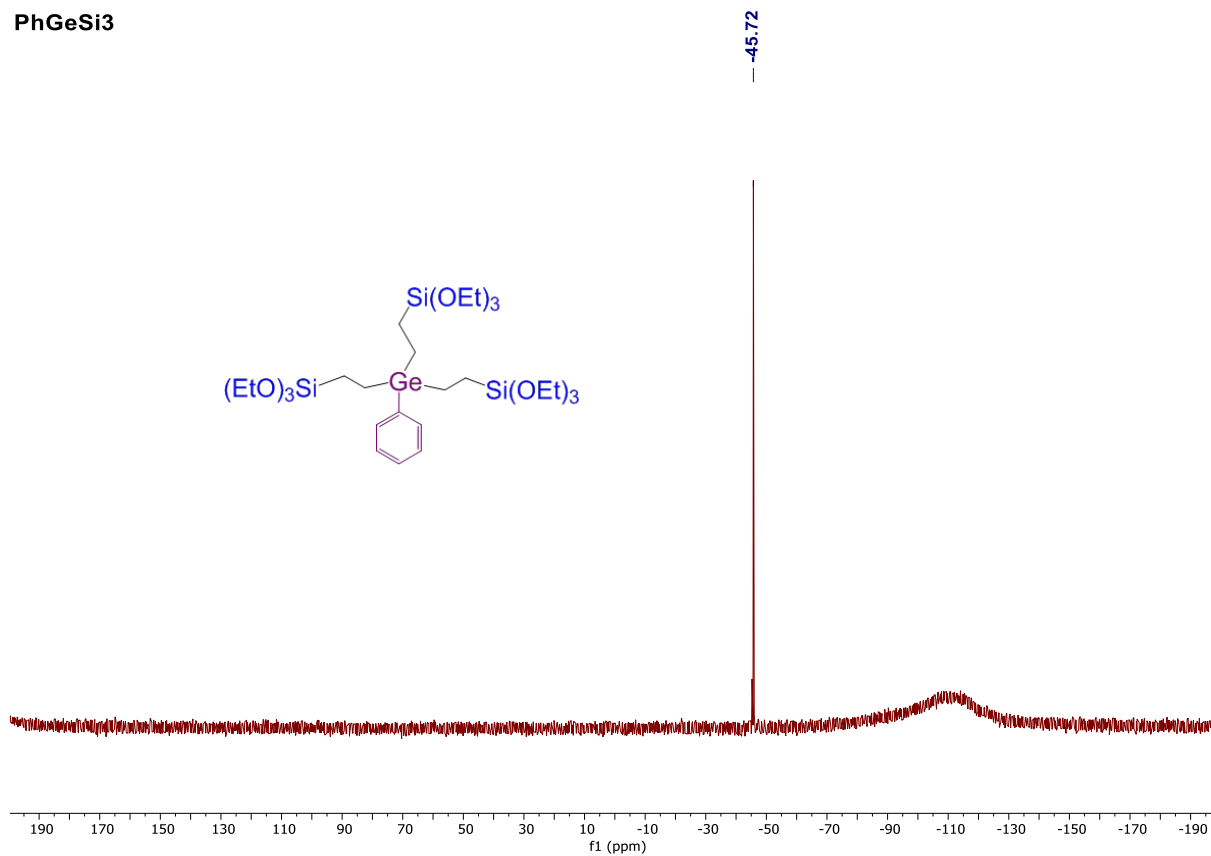
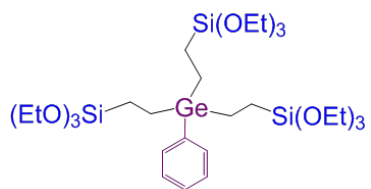
Ph3GeSi



Ph2GeSi2

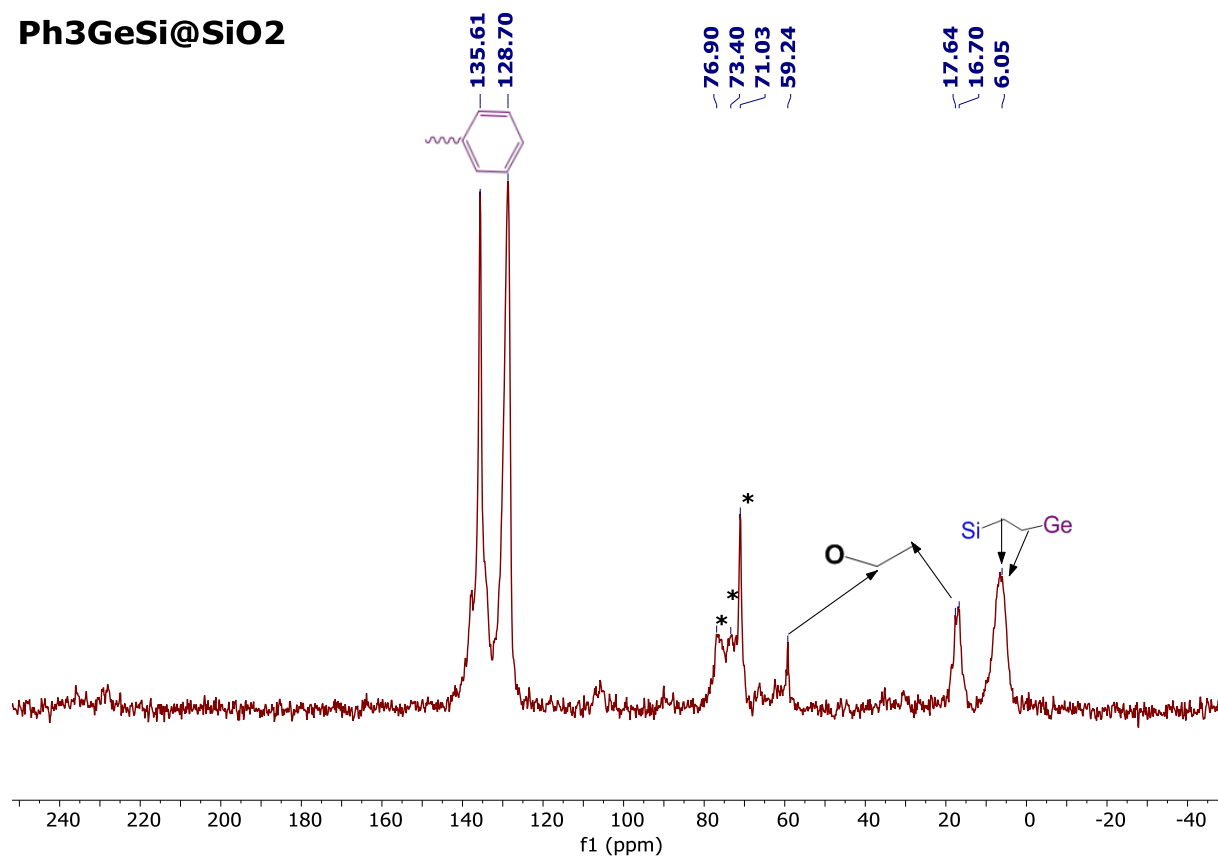


PhGeSi3

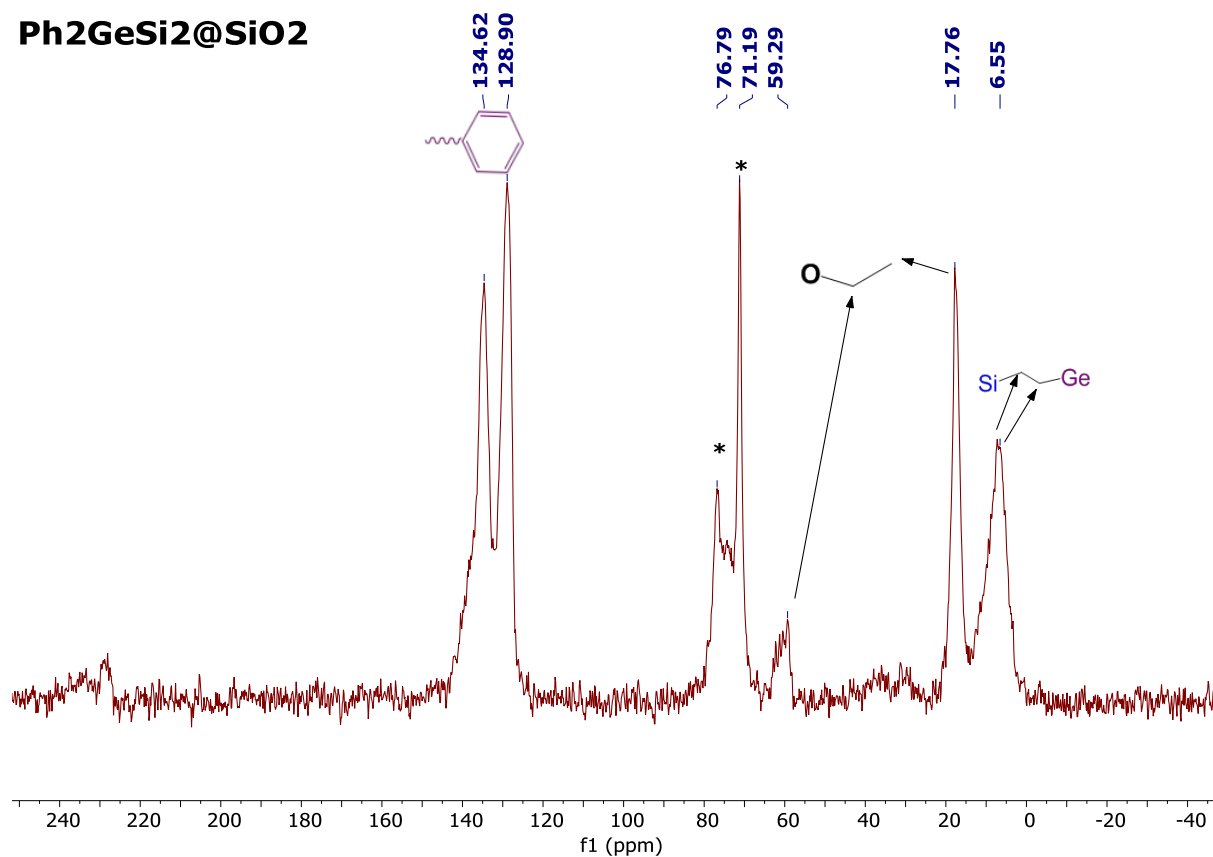


S4. CP MAS ^{13}C and ^{29}Si NMR spectra of $\text{Ph}_3\text{GeSi@SiO}_2$, $\text{Ph}_2\text{GeSi}_2\text{@SiO}_2$ and $\text{PhGeSi}_3\text{@SiO}_2$

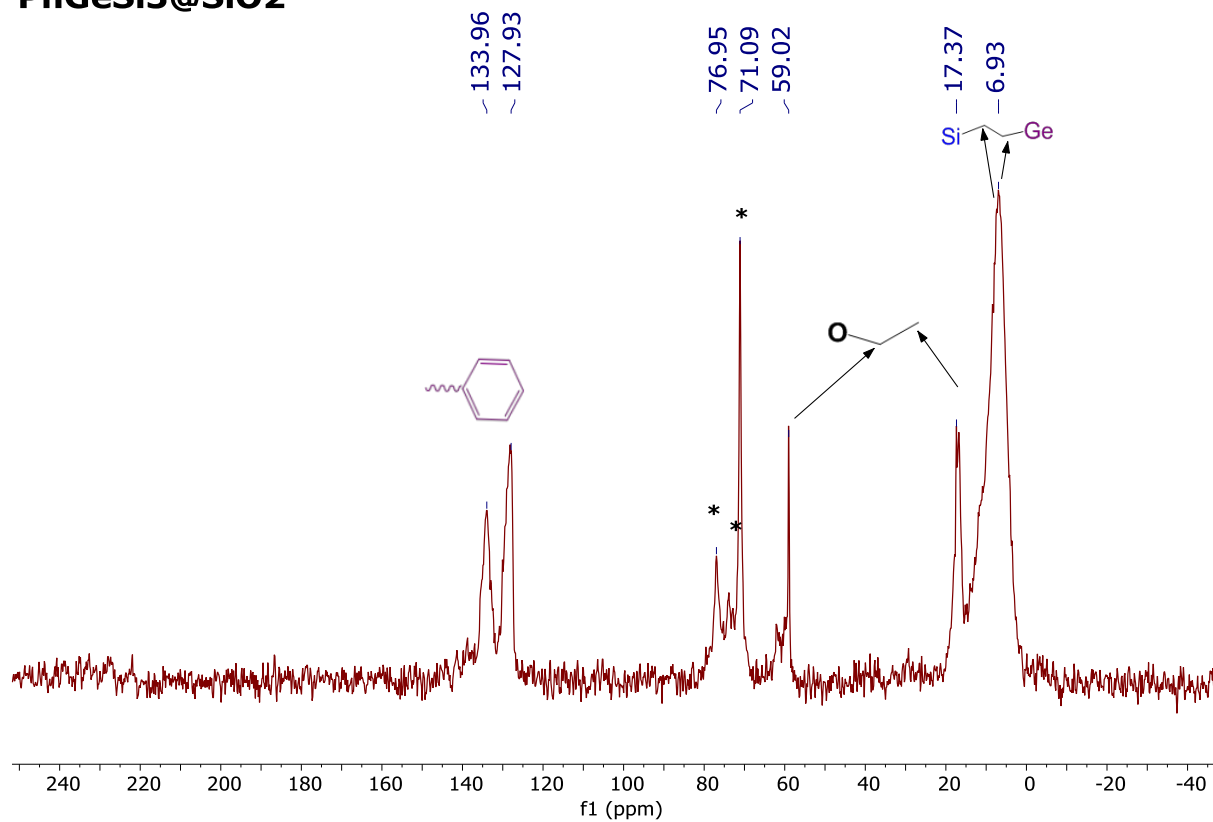
Ph3GeSi@SiO2



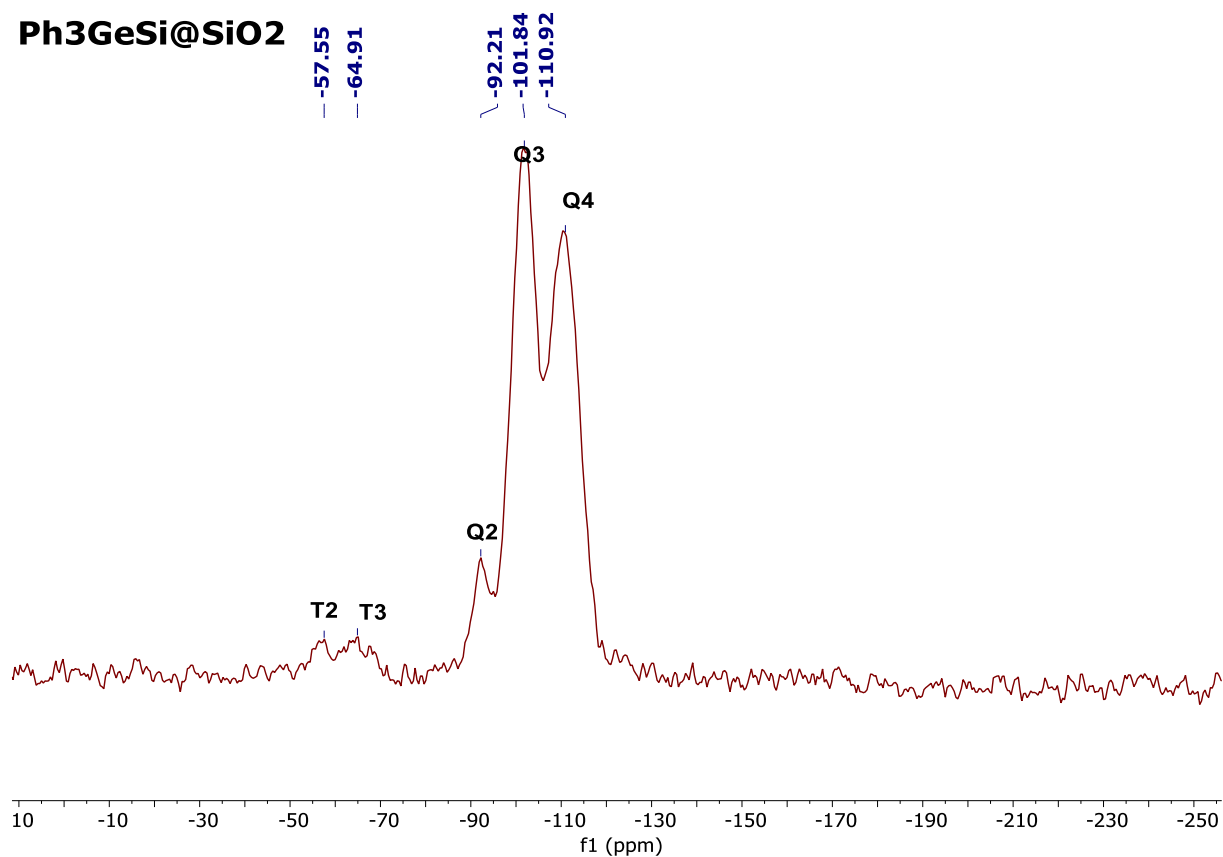
Ph₂GeSi₂@SiO₂



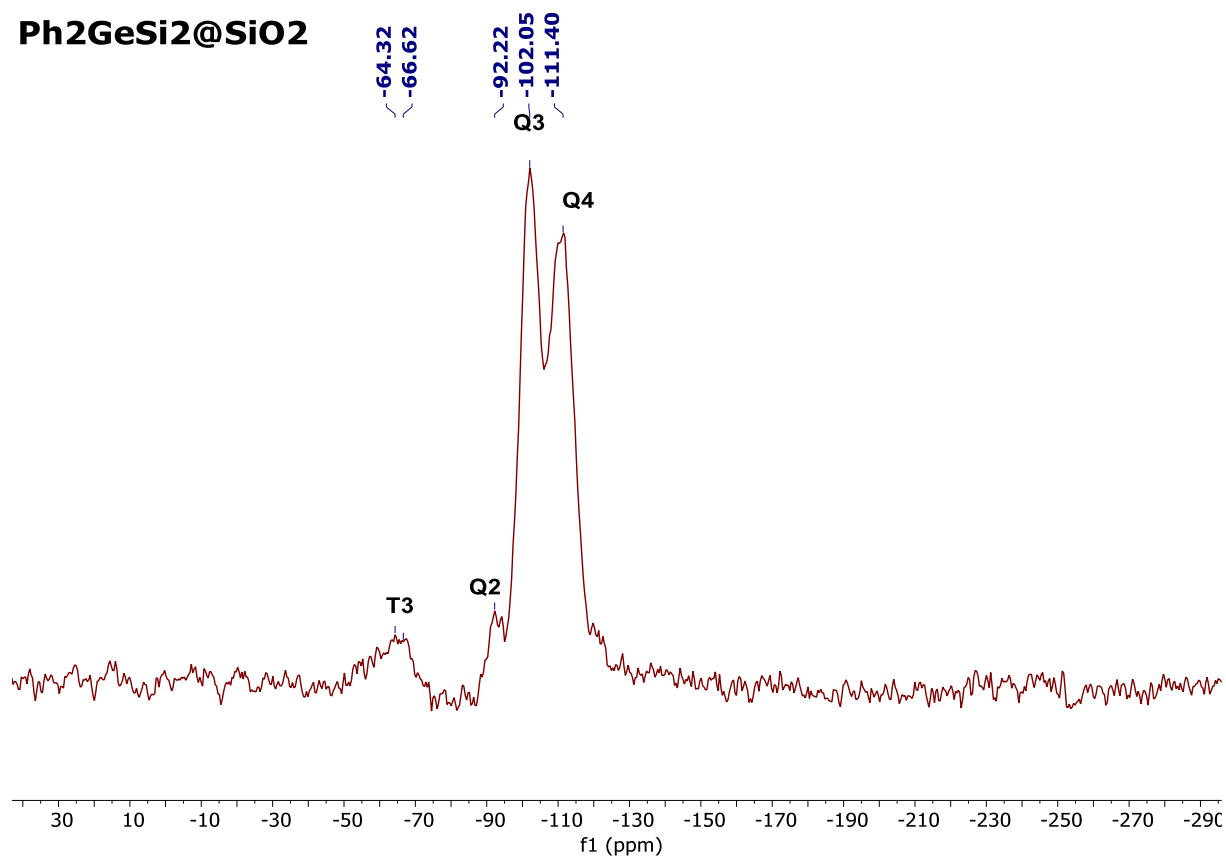
PhGeSi₃@SiO₂



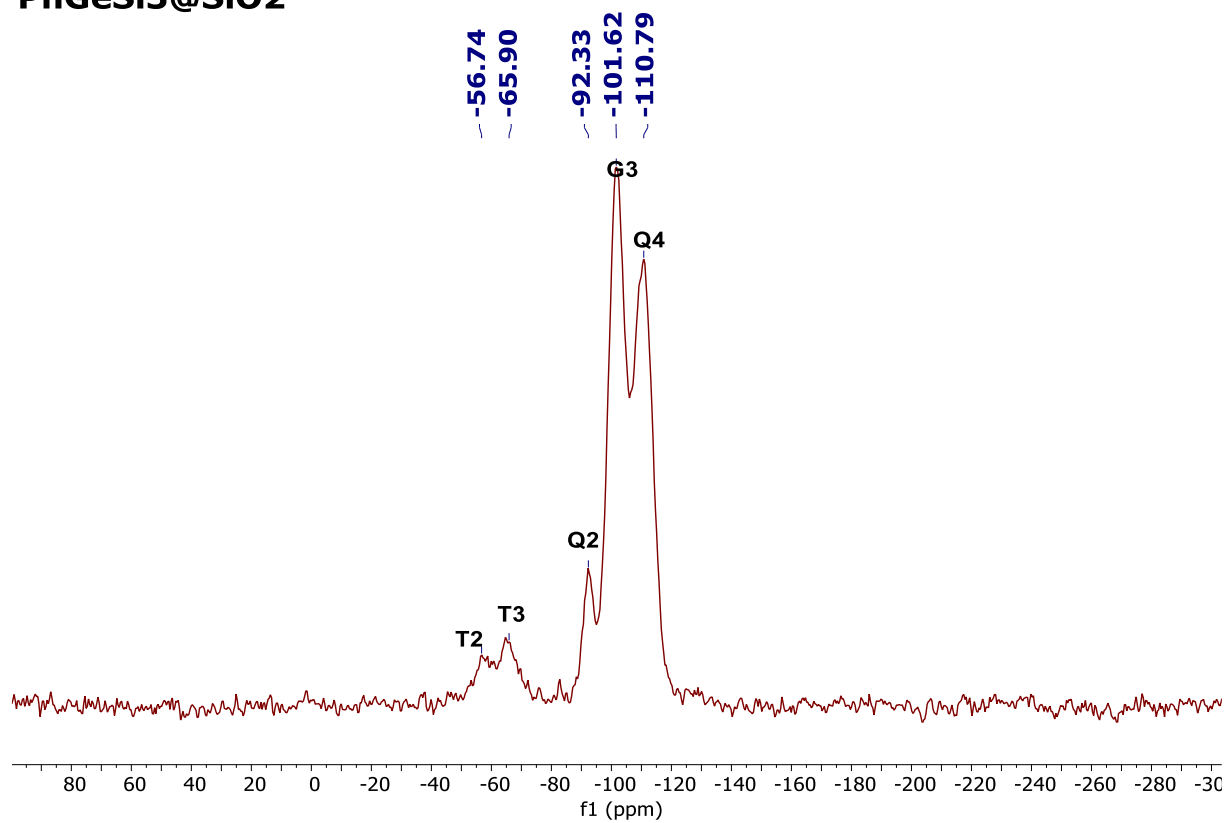
Ph3GeSi@SiO2



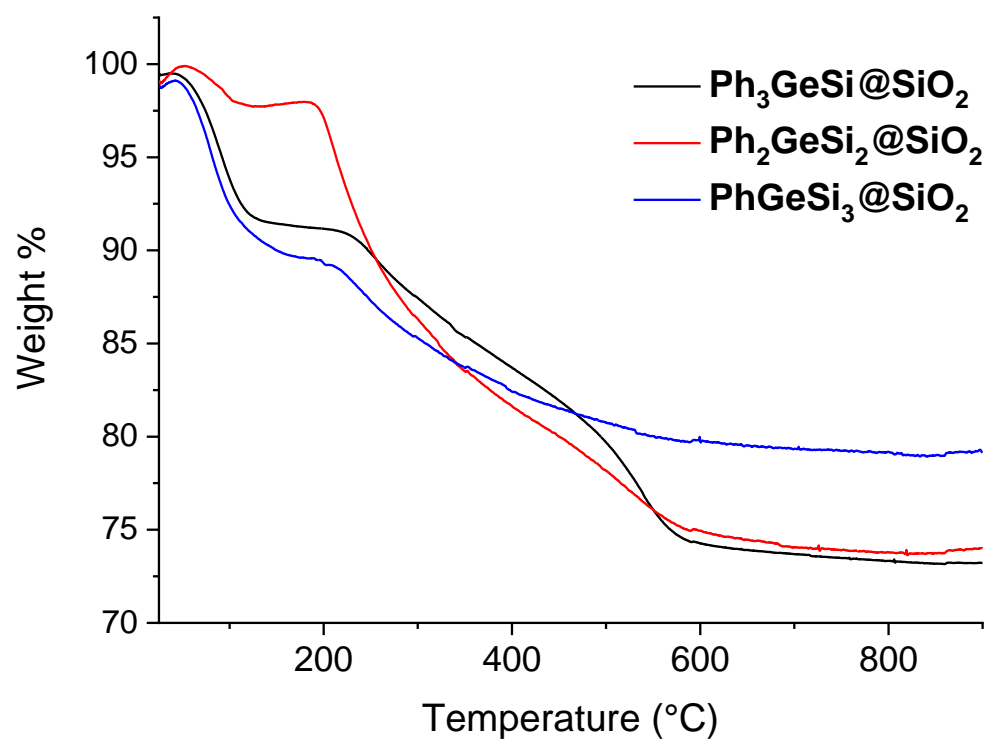
Ph2GeSi2@SiO2



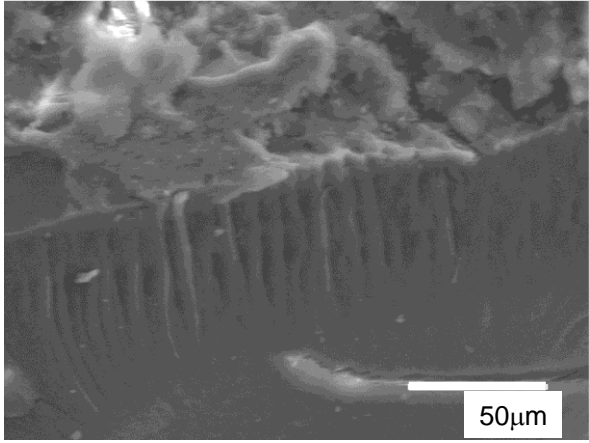
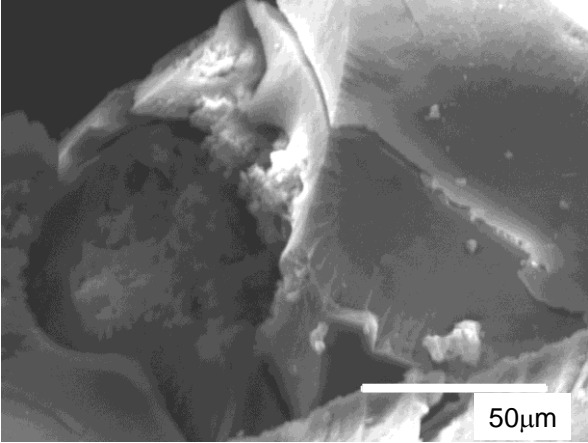
PhGeSi3@SiO2



S5. TGA curves of $\text{Ph}_3\text{GeSi@SiO}_2$, $\text{Ph}_2\text{GeSi}_2\text{@SiO}_2$ and $\text{PhGeSi}_3\text{@SiO}_2$



S6. Scanning electronic microscopy analyses of $Ph_3GeSi@PhSiO_2$



S7. Digital photos of, **CS-Ph₃GeSi@SiO₂**, **CS-Ph₂GeSi₂@SiO₂** and **CS-PhGeSi₃@SiO₂** solutions



CS-Ph₃GeSi@SiO₂

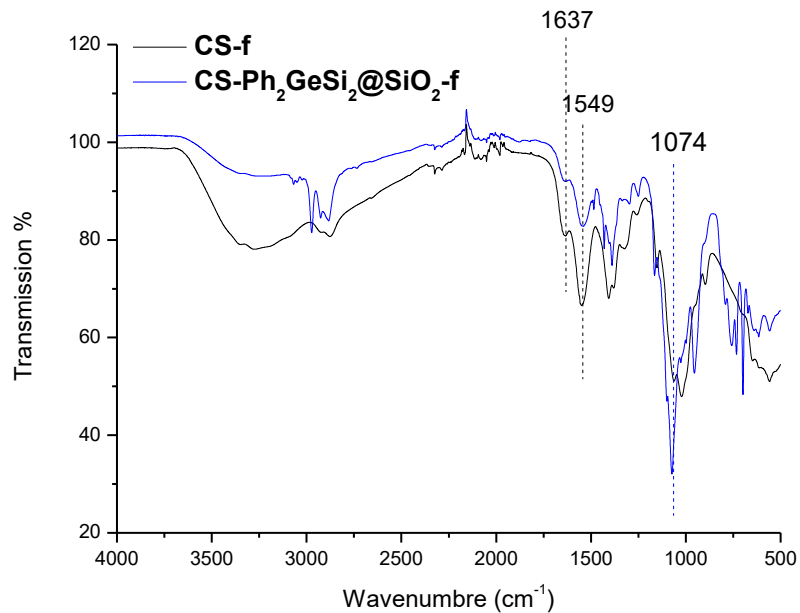
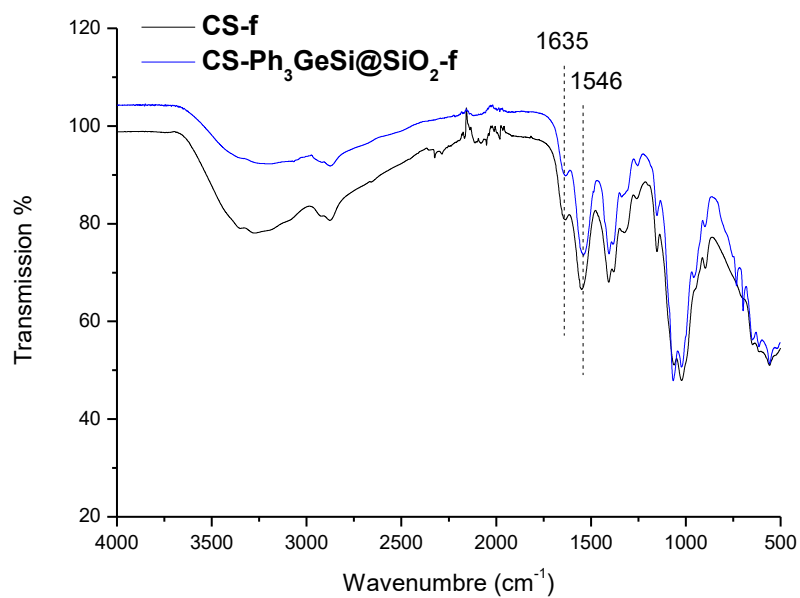


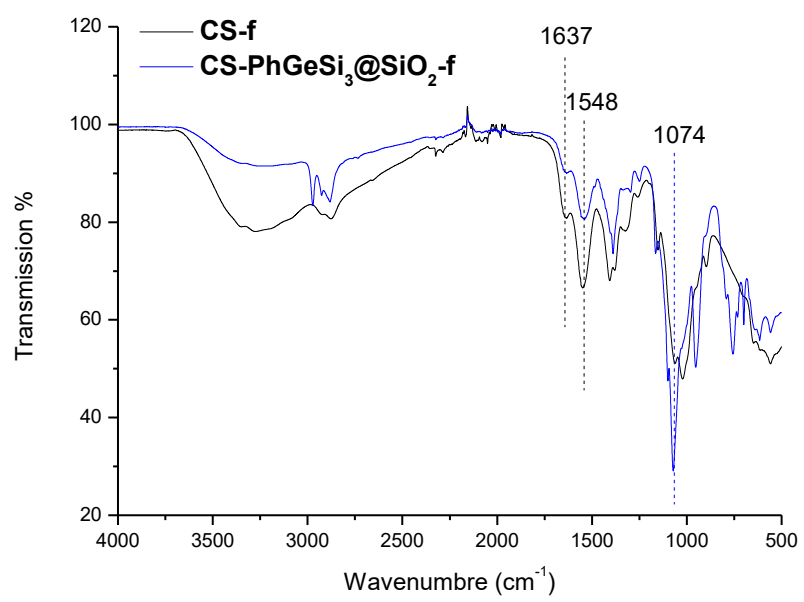
CS-Ph₂GeSi₂@SiO₂



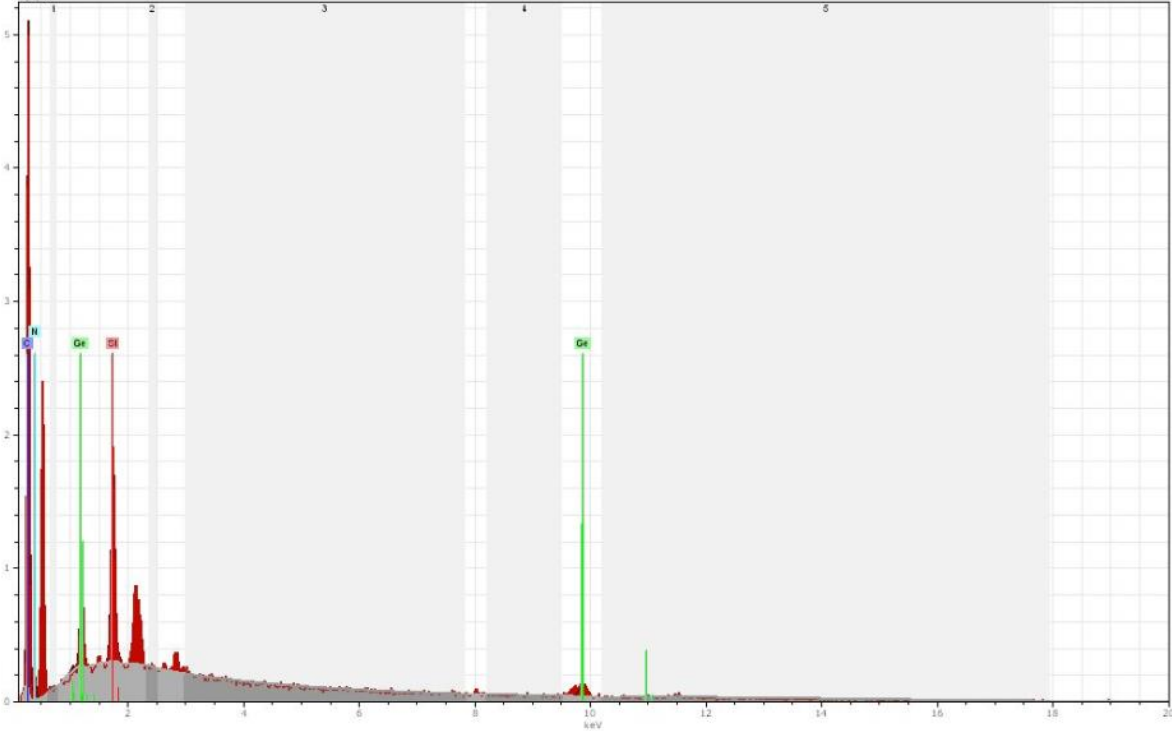
CS-PhGeSi₃@SiO₂

S8. Infrared spectra of CS-Ph₃GeSi@SiO₂-f, CS-Ph₂GeSi₂@SiO₂-f and CS-PhGeSi₃@SiO₂-f

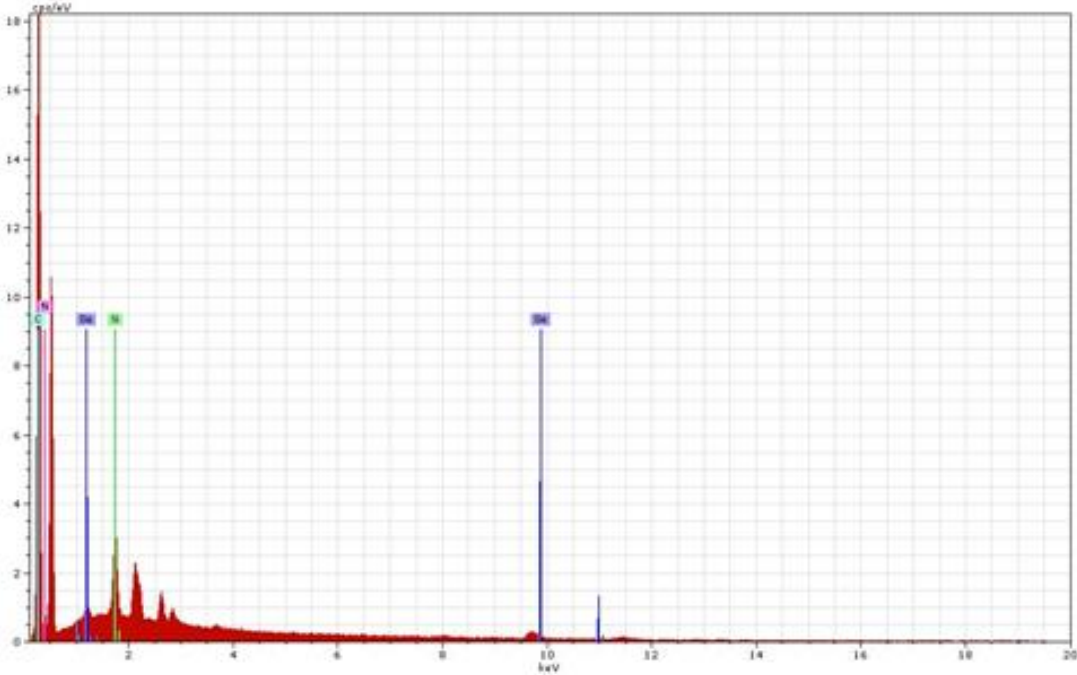




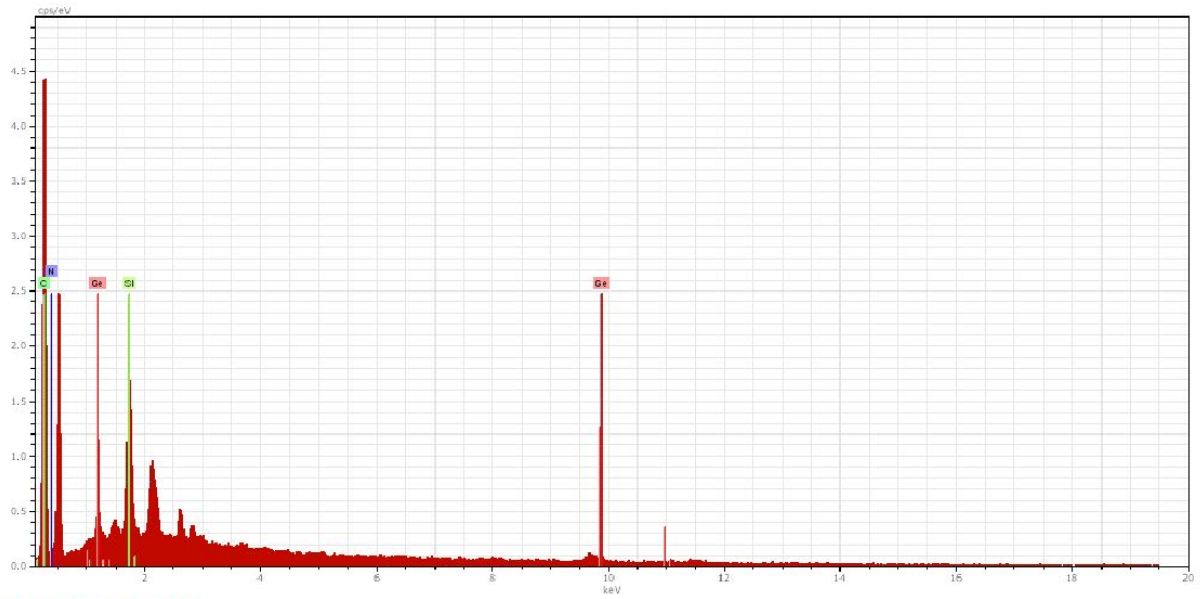
S9. EDX of CS-Ph₃GeSi@SiO₂-f, CS-Ph₂GeSi₂@SiO₂-f and CS-PhGeSi₃@SiO₂-f



CS-Ph₃GeSi@SiO₂-f



CS-Ph₂GeSi₂@SiO₂-f



CS-PhGeSi₃@SiO₂-f

S10. Digital photos and Infrared spectra of CS-Ph₃GeSi@SiO₂-f-150°C, CS-Ph₂GeSi₂@SiO₂-f-150°C and CS-PhGeSi₃@SiO₂-f-150°C



CS-Ph₃GeSi@SiO₂-f-150°C



CS-Ph₂GeSi₂@SiO₂-f-150°C



CS-PhGeSi₃@SiO₂-f-150°C

